

## Quad, SPST Analog Switch

### General Description

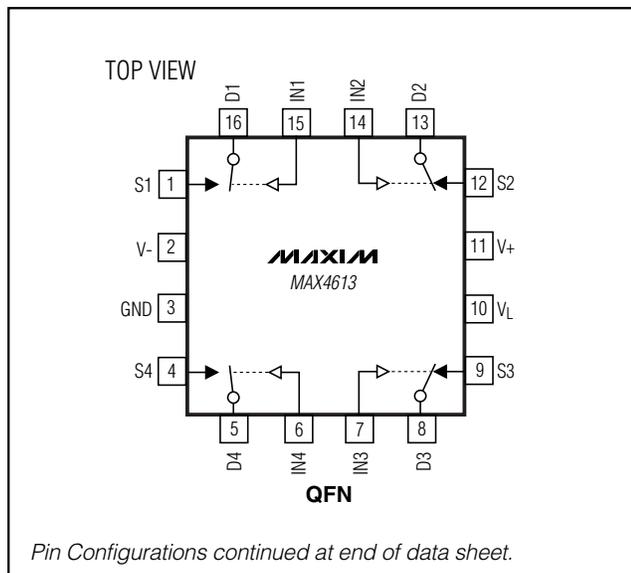
The MAX4613 quad analog switch features on-resistance matching ( $4\Omega$  max) between switches and guarantees on-resistance flatness over the signal range ( $9\Omega$  max). This low on-resistance switch conducts equally well in either direction. It guarantees low charge injection ( $10\text{pC}$  max), low power consumption ( $35\mu\text{W}$  max), and an electrostatic discharge (ESD) tolerance of 2000V minimum per Method 3015.7. The new design offers lower off leakage current over temperature (less than  $5\text{nA}$  at  $+85^\circ\text{C}$ ).

The MAX4613 quad, single-pole/single-throw (SPST) analog switch has two normally closed switches and the two normally open switches. Switching times are less than 250ns for  $t_{\text{ON}}$  and less than 70ns for  $t_{\text{OFF}}$ . Operation is from a single  $+4.5\text{V}$  to  $+40\text{V}$  supply or bipolar  $\pm 4.5\text{V}$  to  $\pm 20\text{V}$  supplies.

### Applications

Sample-and-Hold Circuits	Communication Systems
Test Equipment	Battery-Operated Systems
Heads-Up Displays	PBX, PABX
Guidance and Control Systems	Audio Signal Routing
Military Radios	Modems/Faxes

### Pin Configurations/ Functional Diagrams/Truth Table



Rail-to-Rail is a registered trademark of Nippon Motorola Ltd.

### Features

- ◆ Pin Compatible with Industry-Standard DG213
- ◆ Guaranteed  $R_{\text{ON}}$  Match Between Channels ( $4\Omega$  max)
- ◆ Guaranteed  $R_{\text{FLAT(ON)}}$  Over Signal Range ( $9\Omega$  max)
- ◆ Guaranteed Charge Injection ( $10\text{pC}$  max)
- ◆ Low Off Leakage Current Over Temperature ( $<5\text{nA}$  at  $+85^\circ\text{C}$ )
- ◆ Withstands 2000V min ESD, per Method 3015.7
- ◆ Low  $R_{\text{DS(ON)}}$  ( $85\Omega$  max)
- ◆ Single-Supply Operation  $+4.5\text{V}$  to  $+40\text{V}$   
Bipolar-Supply Operation  $\pm 4.5\text{V}$  to  $\pm 20\text{V}$
- ◆ Low Power Consumption ( $35\mu\text{W}$  max)
- ◆ Rail-to-Rail<sup>®</sup> Signal Handling
- ◆ TTL/CMOS-Logic Compatible

### Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MAX4613CPE	$0^\circ\text{C}$ to $+70^\circ\text{C}$	16 Plastic DIP
MAX4613CSE	$0^\circ\text{C}$ to $+70^\circ\text{C}$	16 Narrow SO
MAX4613CEE	$0^\circ\text{C}$ to $+70^\circ\text{C}$	16 QSOP
MAX4613CUE	$0^\circ\text{C}$ to $+70^\circ\text{C}$	16 TSSOP**
MAX4613C/D	$0^\circ\text{C}$ to $+70^\circ\text{C}$	Dice*
MAX4613EGE	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	16 QFN
MAX4613EPE	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	16 Plastic DIP
MAX4613ESE	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	16 Narrow SO
MAX4613EEE	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	16 QSOP
MAX4613EUE	$-40^\circ\text{C}$ to $+85^\circ\text{C}$	16 TSSOP**

\*Contact factory for dice specifications.

\*\*Contact factory for availability.

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## ABSOLUTE MAXIMUM RATINGS

Voltage Referenced to GND	Continuous Power Dissipation ( $T_A = +70^\circ\text{C}$ )
V+ .....+44V	Plastic DIP (derate 10.53mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$ ) .....842mW
V- .....-44V	Narrow SO (derate 8.70mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$ ) .....696mW
V+ to V- .....+44V	QSOP (derate 8.3mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$ ) .....667mW
V <sub>L</sub> .....(GND - 0.3V) to (V+ + 0.3V)	QFN (derate 19.2mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$ ) .....1538mW
Digital Inputs V <sub>S</sub> , V <sub>D</sub> (Note 1) .....(V- - 2V) to (V+ + 2V)	TSSOP (derate 6.7mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$ ) .....457mW
or 30mA (whichever occurs first)	Operating Temperature Ranges
Continuous Current (any terminal) .....30mA	MAX4613C_ _ .....0 $^\circ\text{C}$ to $+70^\circ\text{C}$
Peak Current, S_ or D_	MAX4613E_ _ .....-40 $^\circ\text{C}$ to $+85^\circ\text{C}$
(pulsed at 1ms, 10% duty cycle max) .....100mA	Storage Temperature Range .....-65 $^\circ\text{C}$ to $+165^\circ\text{C}$
	Lead Temperature (soldering, 10sec) .....+300 $^\circ\text{C}$

**Note 1:** Signals on S\_, D\_, or IN\_ exceeding V+ or V- are clamped by internal diodes. Limit forward current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS—Dual Supplies

(V+ = 15V, V- = -15V, V<sub>L</sub> = 5V, GND = 0V, V<sub>INH</sub> = 2.4V, V<sub>INL</sub> = 0.8V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP (Note 2)	MAX	UNITS
<b>SWITCH</b>						
Analog Signal Range	V <sub>ANALOG</sub>	(Note 3)	-15		15	V
Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>D</sub> = $\pm 10\text{V}$ , I <sub>S</sub> = 1mA	T <sub>A</sub> = $+25^\circ\text{C}$		55	70
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>			85
On-Resistance Match Between Channels (Note 4)	$\Delta R_{DS(ON)}$	V <sub>D</sub> = $\pm 10\text{V}$ , I <sub>S</sub> = 1mA	T <sub>A</sub> = $+25^\circ\text{C}$			4
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>			5
On-Resistance Flatness (Note 4)	R <sub>FLAT(ON)</sub>	V <sub>D</sub> = $\pm 5\text{V}$ , I <sub>S</sub> = 1mA	T <sub>A</sub> = $+25^\circ\text{C}$			9
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>			15
Source Leakage Current (Note 5)	I <sub>S(OFF)</sub>	V <sub>D</sub> = $\pm 14\text{V}$ , V <sub>S</sub> = $\mp 14\text{V}$	T <sub>A</sub> = $+25^\circ\text{C}$		-0.50	0.01 0.50
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>		-5	5
Drain-Off Leakage Current (Note 5)	I <sub>D(OFF)</sub>	V <sub>D</sub> = $\pm 14\text{V}$ , V <sub>S</sub> = $\mp 14\text{V}$	T <sub>A</sub> = $+25^\circ\text{C}$		-0.50	0.01 0.50
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>		-5	5
Drain-On Leakage Current (Note 5)	I <sub>D(ON)</sub> or I <sub>S(ON)</sub>	V <sub>D</sub> = $\pm 14\text{V}$ , V <sub>S</sub> = $\pm 14\text{V}$	T <sub>A</sub> = $+25^\circ\text{C}$		-0.50	0.08 0.50
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>		-10	10
<b>INPUT</b>						
Input Current with Input Voltage High	I <sub>INH</sub>	V <sub>IN</sub> = 2.4V, all others = 0.8V	-0.5	-0.00001	0.5	$\mu\text{A}$
Input Current with Input Voltage Low	I <sub>INL</sub>	V <sub>IN</sub> = 0.8V, all others = 2.4V	-0.5	-0.00001	0.5	$\mu\text{A}$
<b>SUPPLY</b>						
Power-Supply Range	V+, V-		$\pm 4.5$		$\pm 20.0$	V
Positive Supply Current	I+	All channels on or off, V <sub>IN</sub> = 0 or 5V	T <sub>A</sub> = $+25^\circ\text{C}$		-1	0.001 1
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>		-5	5
Negative Supply Current	I-	All channels on or off, V <sub>IN</sub> = 0 or 5V	T <sub>A</sub> = $+25^\circ\text{C}$		-1	0.001 1
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>		-5	5

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MAX4613

## ELECTRICAL CHARACTERISTICS—Dual Supplies (continued)

(V<sub>+</sub> = 15V, V<sub>-</sub> = -15V, V<sub>L</sub> = 5V, GND = 0V, V<sub>INH</sub> = 2.4V, V<sub>INL</sub> = 0.8V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP (Note 2)	MAX	UNITS	
Logic Supply Current	I <sub>L</sub>	All channels on or off, V <sub>IN</sub> = 0 or 5V	T <sub>A</sub> = +25°C	-1	0.001	1	μA
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>	-5		5	
Ground Current	I <sub>GND</sub>	All channels on or off, V <sub>IN</sub> = 0 or 5V	T <sub>A</sub> = +25°C	-1	-0.0001	1	μA
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>	-5		5	
<b>DYNAMIC</b>							
Turn-On Time (Note 3)	t <sub>ON</sub>	V <sub>S</sub> = ±10V, Figure 2	T <sub>A</sub> = +25°C	150	250	ns	
Turn-Off Time (Note 3)	t <sub>OFF</sub>	V <sub>S</sub> = ±10V, Figure 2	T <sub>A</sub> = +25°C	90	120	ns	
Break-Before-Make Time Delay (Note 3)	t <sub>D</sub>	Figure 3	T <sub>A</sub> = +25°C	5	20	ns	
Charge Injection (Note 3)	Q	C <sub>L</sub> = 1nF, V <sub>GEN</sub> = 0, R <sub>GEN</sub> = 0, Figure 4	T <sub>A</sub> = +25°C	5	10	pC	
Off-Isolation Rejection Ratio (Note 6)	OIRR	R <sub>L</sub> = 50Ω, C <sub>L</sub> = 5pF, f = 1MHz, Figure 5	T <sub>A</sub> = +25°C	60		dB	
Crosstalk (Note 7)		R <sub>L</sub> = 50Ω, C <sub>L</sub> = 5pF, f = 1MHz, Figure 6	T <sub>A</sub> = +25°C	100		dB	
Source-Off Capacitance	C <sub>S(OFF)</sub>	f = 1MHz, Figure 7	T <sub>A</sub> = +25°C	4		pF	
Drain-Off Capacitance	C <sub>D(OFF)</sub>	f = 1MHz, Figure 7	T <sub>A</sub> = +25°C	4		pF	
Source-On Capacitance	C <sub>S(ON)</sub>	f = 1MHz, Figure 8	T <sub>A</sub> = +25°C	16		pF	
Drain-On Capacitance	C <sub>D(ON)</sub>	f = 1MHz, Figure 8	T <sub>A</sub> = +25°C	16		pF	

## ELECTRICAL CHARACTERISTICS—Single Supply

(V<sub>+</sub> = 12V, V<sub>-</sub> = 0V, V<sub>L</sub> = 5V, GND = 0V, V<sub>INH</sub> = 2.4V, V<sub>INL</sub> = 0.8V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP (Note 2)	MAX	UNITS	
<b>SWITCH</b>							
Analog Signal Range	V <sub>ANALOG</sub>		0		12	V	
Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>L</sub> = 5V; V <sub>D</sub> = 3V, 8V; I <sub>S</sub> = 1mA	T <sub>A</sub> = +25°C	100	160	Ω	
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>		200		
<b>SUPPLY</b>							
Power-Supply Range	V <sub>+</sub> , V <sub>-</sub>		4.5		40	V	
Power-Supply Current	I <sub>+</sub>	All channels on or off, V <sub>IN</sub> = 0 or 5V	T <sub>A</sub> = +25°C	-1	0.001	1	μA
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>	-5		5	
Negative Supply Current	I <sub>-</sub>	All channels on or off, V <sub>IN</sub> = 0 or 5V	T <sub>A</sub> = +25°C	-1	-0.0001	1	μA
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>	-5		5	
Logic Supply Current	I <sub>L</sub>	All channels on or off, V <sub>IN</sub> = 0 or 5V	T <sub>A</sub> = +25°C	-1	0.001	1	μA
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>	-5		5	
Ground Current	I <sub>GND</sub>	All channels on or off, V <sub>IN</sub> = 0 or 5V	T <sub>A</sub> = +25°C	-1	-0.0001	1	μA
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>	-5		5	

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## ELECTRICAL CHARACTERISTICS—Single Supply (continued)

( $V_+ = 12V$ ,  $V_- = 0$ ,  $V_L = 5V$ ,  $GND = 0V$ ,  $V_{INH} = 2.4V$ ,  $V_{INL} = 0.8V$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP (Note 2)	MAX	UNITS
<b>DYNAMIC</b>						
Turn-On Time (Note 3)	$t_{ON}$	$V_S = 8V$ , Figure 2		300	400	ns
Turn-Off Time (Note 3)	$t_{OFF}$	$V_S = 8V$ , Figure 2		60	200	ns
Charge Injection (Note 3)	Q	$C_L = 1nF$ , $V_{GEN} = 0$ , $R_{GEN} = 0$ , Figure 4		5	10	pC

**Note 2:** Typical values are for **design aid only**, are not guaranteed and are not subject to production testing. The algebraic convention, where the most negative value is a minimum and the most positive value a maximum, is used in this data sheet.

**Note 3:** Guaranteed by design.

**Note 4:** On-resistance match between channels and flatness are guaranteed only with bipolar-supply operation. Flatness is defined as the difference between the maximum and the minimum value of on-resistance as measured at the extremes of the specified analog signal range.

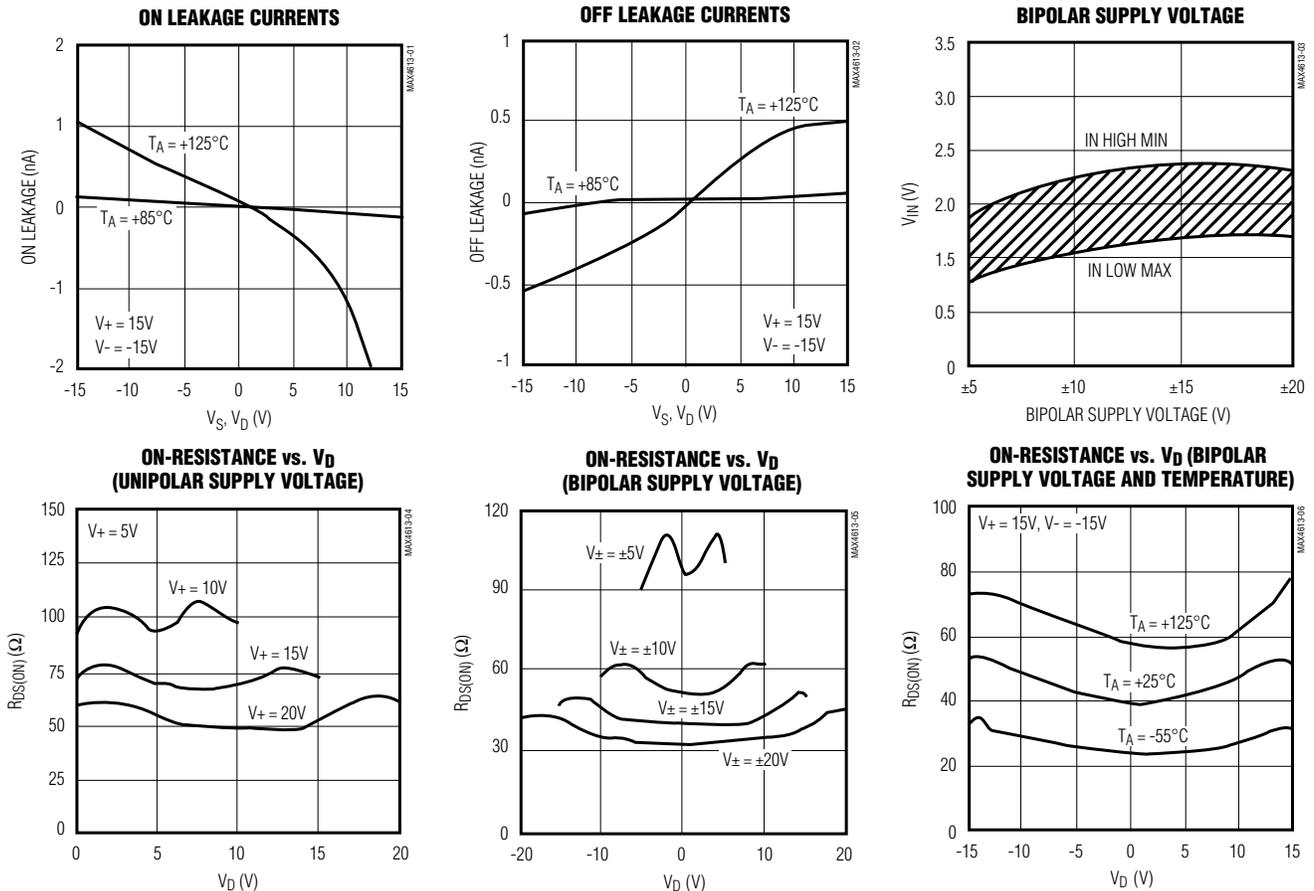
**Note 5:** Leakage parameters  $I_{S(OFF)}$ ,  $I_{D(OFF)}$ ,  $I_{D(ON)}$ , and  $I_{S(ON)}$  are 100% tested at the maximum rated hot temperature and guaranteed at +25°C.

**Note 6:** Off-Isolation Rejection Ratio =  $20 \log (V_D/V_S)$ .

**Note 7:** Between any two switches.

## Typical Operating Characteristics

( $T_A = +25^\circ C$ , unless otherwise noted.)



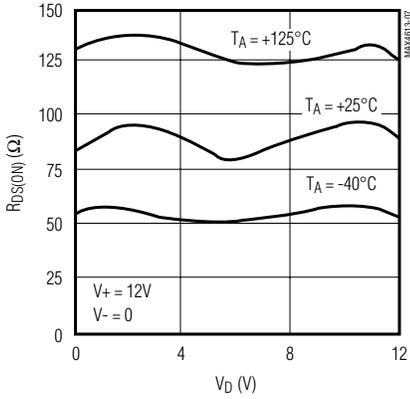
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## Typical Operating Characteristics (continued)

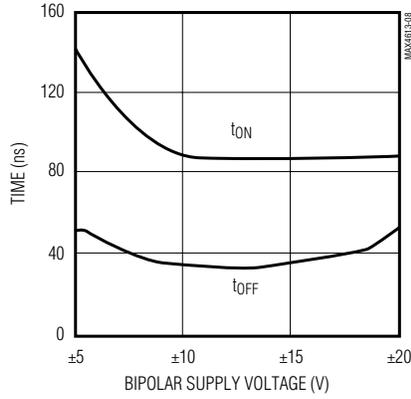
( $T_A = +25^\circ\text{C}$ , unless otherwise noted.)

**MAX4613**

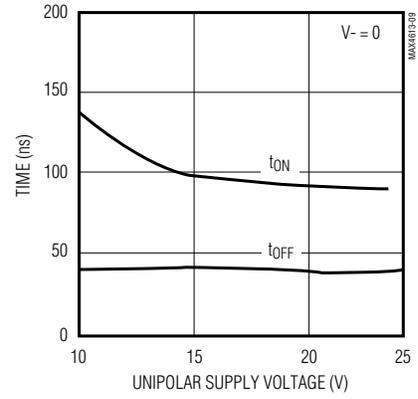
**ON-RESISTANCE vs.  $V_D$  (UNIPOLAR SUPPLY VOLTAGE AND TEMPERATURE)**



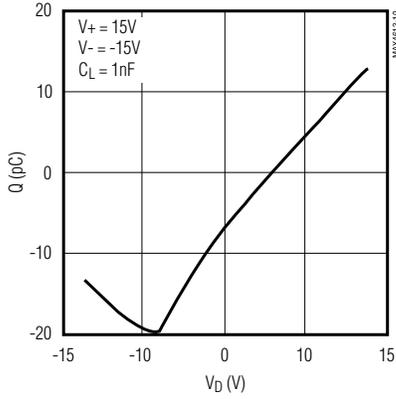
**SWITCHING TIME vs. BIPOLEAR SUPPLY VOLTAGE**



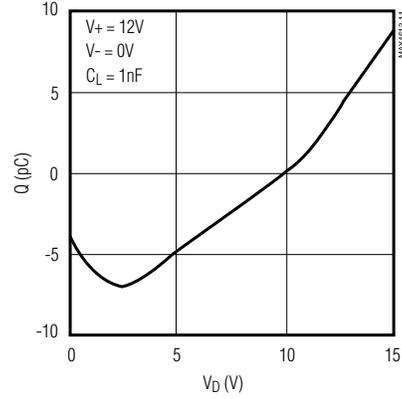
**SWITCHING TIME vs. UNIPOLAR SUPPLY VOLTAGE**



**CHARGE INJECTION vs.  $V_D$  VOLTAGE**



**CHARGE INJECTION vs.  $V_D$  VOLTAGE**



# Quad, SPST Analog Switch

## Pin Description

PIN		NAME	FUNCTION
DIP/SO/TSSOP	QFN		
1, 8, 9, 16	6, 7, 14, 15	IN1–IN4	Logic Control Input
2, 7, 10, 15	5, 8, 13, 16	D1–D4	Analog-Switch Drain Output
3, 6, 11, 14	1, 4, 9, 12	S1–S4	Analog-Switch Source Output
4	2	V-	Negative-Supply Voltage Input
5	3	GND	Ground
12	10	V <sub>L</sub>	Logic-Supply Voltage Input
13	11	V+	Positive-Supply Voltage Input—Connected to Substrate

## Applications Information

### General Operation

- 1) Switches are open when power is off.
- 2) IN<sub>-</sub>, D<sub>-</sub>, and S<sub>-</sub> should not exceed V<sub>+</sub> or V<sub>-</sub>, even with the power off.
- 3) Switch leakage is from each analog switch terminal to V<sub>+</sub> or V<sub>-</sub>, not to other switch terminals.

### Operation with Supply Voltages Other than ±15V

Using supply voltages less than ±15V will reduce the analog signal range. The MAX4613 operates with ±4.5V to ±20V bipolar supplies or with a +4.5V to +40V single supply; connect V<sub>-</sub> to GND when operating with a single supply. Also, all device types can operate with unbalanced supplies such as +24V and -5V. V<sub>L</sub> must be connected to +5V to be TTL compatible, or to V<sub>+</sub> for CMOS-logic level inputs. The *Typical Operating Characteristics* graphs show typical on-resistance with ±20V, ±15V, ±10V, and ±5V supplies. (Switching times increase by a factor of two or more for operation at ±5V.)

### Overvoltage Protection

Proper power-supply sequencing is recommended for all CMOS devices. Do not exceed the absolute maximum ratings because stresses beyond the listed ratings may cause permanent damage to the devices. Always sequence V<sub>+</sub> on first, followed by

V<sub>L</sub>, V<sub>-</sub>, and logic inputs. If power-supply sequencing is not possible, add two small, external signal diodes in series with supply pins for overvoltage protection (Figure 1). Adding diodes reduces the analog signal range to 1V below V<sub>+</sub> and 1V above V<sub>-</sub>, but low switch resistance and low leakage characteristics are unaffected. Device operation is unchanged, and the difference between V<sub>+</sub> and V<sub>-</sub> should not exceed +44V.

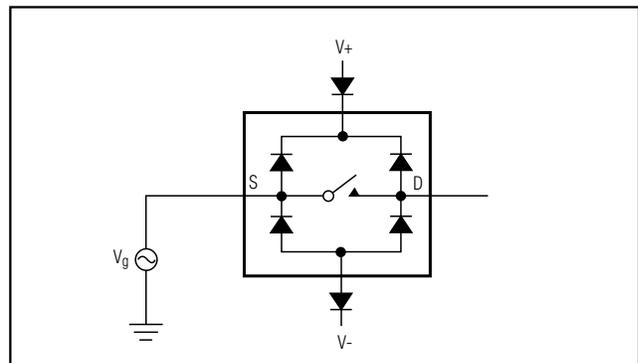


Figure 1. Overvoltage Protection Using External Blocking Diodes

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## Timing Diagrams/Test Circuits

**MAX4613**

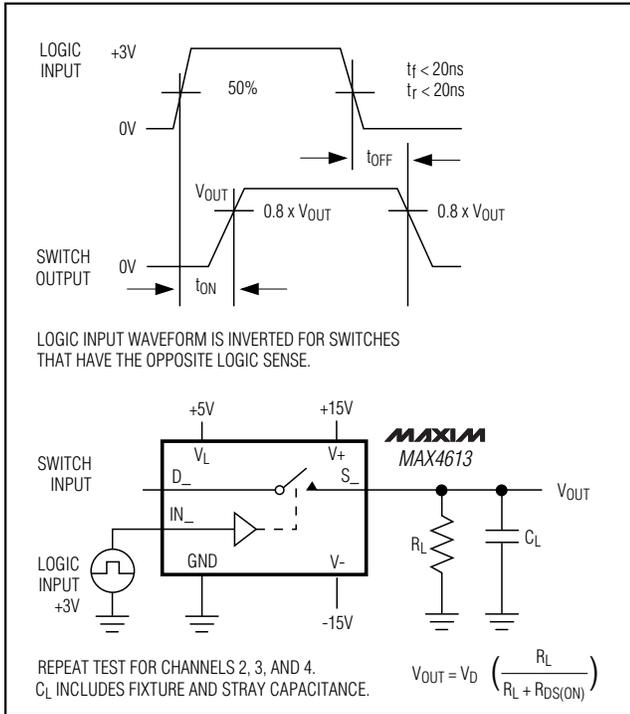


Figure 2. Switching Time

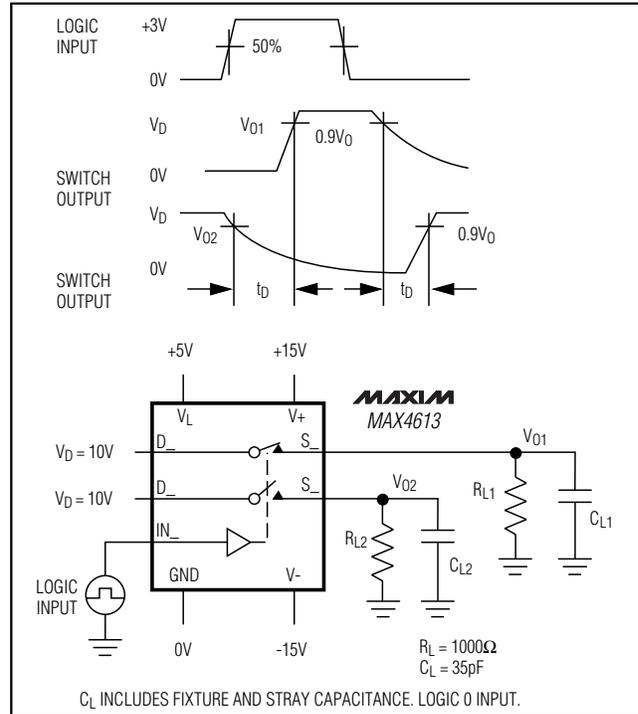


Figure 3. Break-Before-Make Test Circuit

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## Timing Diagrams/Test Circuits (continued)

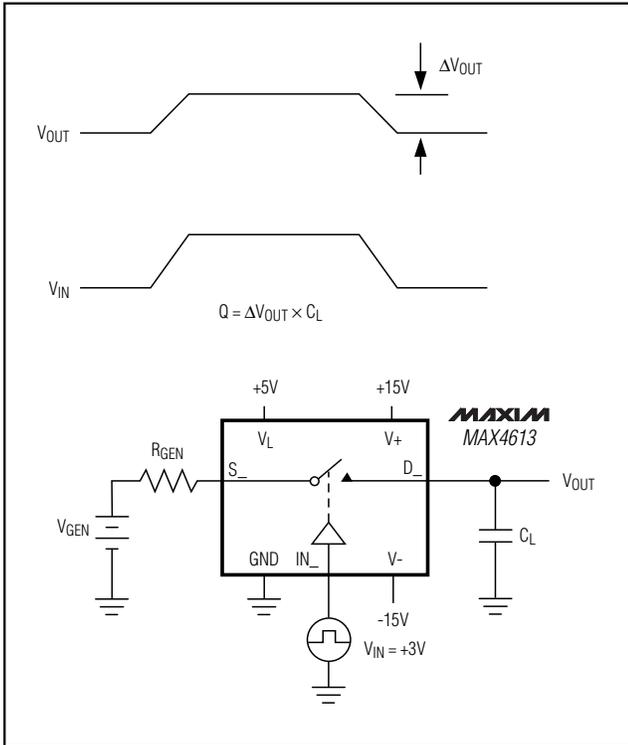


Figure 4. Charge Injection

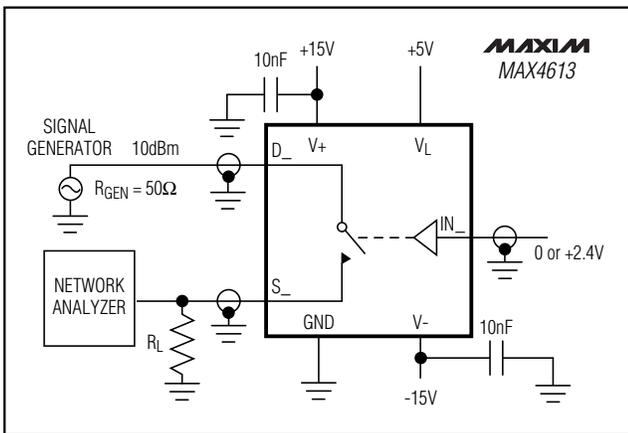


Figure 5. Off-Isolation Rejection Ratio

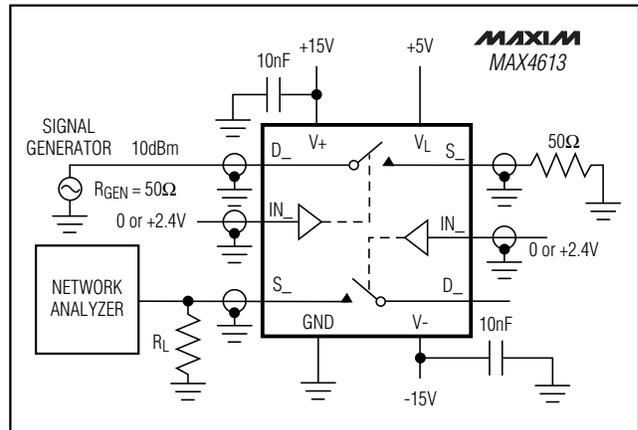


Figure 6. Crosstalk

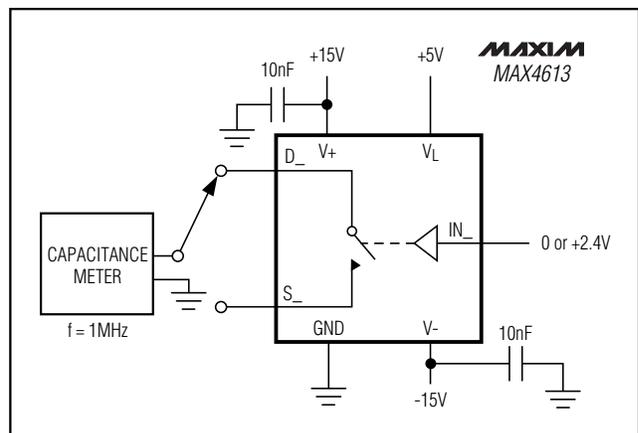


Figure 7. Source/Drain-Off Capacitance

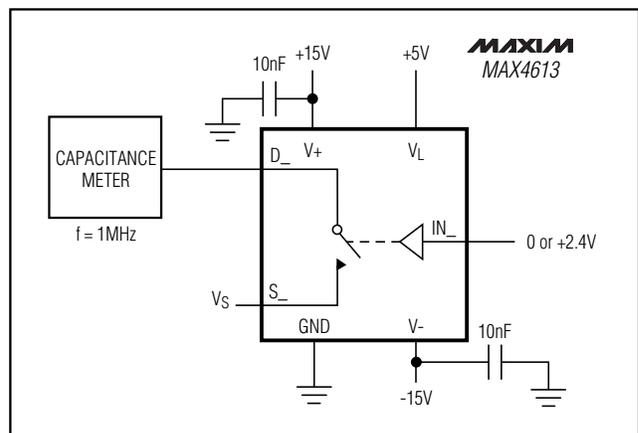
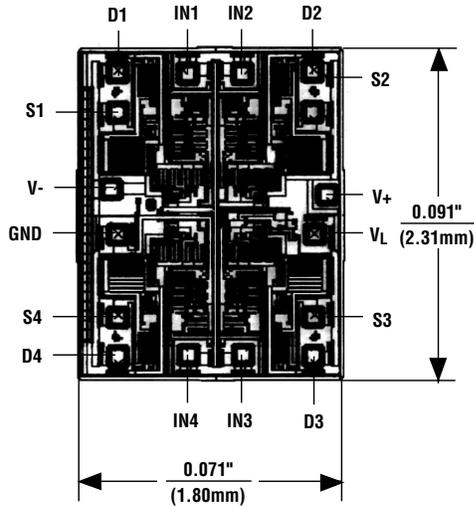


Figure 8. Source/Drain-On Capacitance

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**MAX4613**

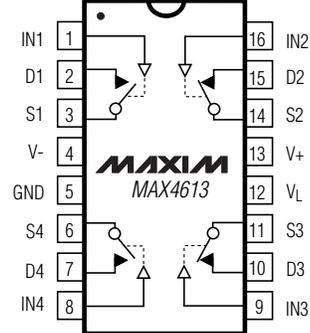
## Chip Topography



TRANSISTOR COUNT: 126  
SUBSTRATE CONNECTED TO V+

## Pin Configurations (continued)

TOP VIEW



DIP/ISO/QSOP/TSSOP

LOGIC	SW <sub>1</sub> , SW <sub>4</sub>	SW <sub>2</sub> , SW <sub>3</sub>
0	OFF	ON
1	ON	OFF

SWITCHES SHOWN FOR LOGIC "0" INPUT

## Package Information

COMMON DIMENSIONS					
DIM.	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	0.05	0.15	.002	.006	
A <sub>1</sub>	0.85	0.95	.033	.037	
b	0.19	0.30	.007	.012	
bl	0.19	0.25	.007	.010	
c	0.090	0.20	.0035	.008	
cl	0.090	0.135	.0035	.0053	
D	SEE VARIATIONS SEE VARIATIONS				
E	4.30	4.50	.169	.177	
e	0.65 BSC		.026 BSC		
H	6.25	6.50	.246	.256	
L	0.50	0.70	.020	.028	
N	SEE VARIATIONS SEE VARIATIONS				
Y	2.85	3.15	.112	.124	
α	0°	8°	0°	8°	

JEDEC	MD-153	N	VARIATIONS			
			MILLIMETERS		INCHES	
			MIN.	MAX.	MIN.	MAX.
AB	14	D	4.90	5.10	.193	.201
AC	16	D	4.90	5.10	.193	.201
AC-EP	16	D	4.90	5.10	.193	.201
		X	2.85	3.15	.112	.124
AD	20	D	6.40	6.60	.252	.260
AD-EP	20	D	6.40	6.60	.252	.260
		X	4.00	4.34	.157	.171
AE	24	D	7.70	7.90	.303	.311
AF	28	D	9.60	9.80	.378	.386
AF-EP	28	D	9.60	9.80	.378	.386
		X	5.35	5.65	.211	.222

NOTES:

- DIMENSIONS D AND E DO NOT INCLUDE FLASH.
- MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .15 mm PER SIDE.
- CONTROLLING DIMENSION: MILLIMETER.
- MEETS JEDEC OUTLINE MD-153 VARIATIONS AB, AC, AD, AE, AF.
- DIMENSIONS X AND Y APPLY TO EXPOSED PAD (EP) VERSIONS ONLY.
- EXPOSED PAD FLUSH WITH BOTTOM OF PACKAGE WITHIN .002".

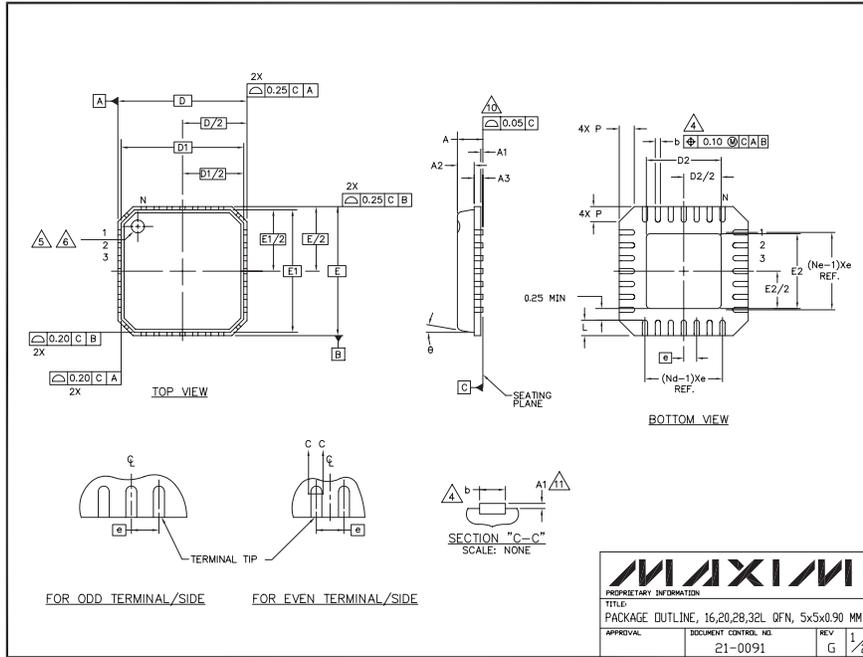
**MAXIM**  
PROPRIETARY INFORMATION

TITLE: PACKAGE OUTLINE, TSSOP, 4.40mm BODY, 0.65mm PITCH

APPROVAL: \_\_\_\_\_ DOCUMENT CONTROL NO: 21-0066 REV: C 1/1

# Quad, SPST Analog Switch

## Package Information (continued)



**NOTES:**

- DIE THICKNESS ALLOWABLE IS 0.305mm MAXIMUM (.012 INCHES MAXIMUM)
- DIMENSIONING & TOLERANCES CONFORM TO ASME Y14.5M. - 1994.
- N IS THE NUMBER OF TERMINALS.  
Nd IS THE NUMBER OF TERMINALS IN X-DIRECTION &  
Ne IS THE NUMBER OF TERMINALS IN Y-DIRECTION.
- DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.20 AND 0.25mm FROM TERMINAL TIP.
- THE PIN #1 IDENTIFIER MUST BE EXISTED ON THE TOP SURFACE OF THE PACKAGE BY USING INDENTATION MARK OR INK/ LASER MARKED.
- EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.
- ALL DIMENSIONS ARE IN MILLIMETERS.
- PACKAGE WARPAGE MAX 0.05mm.
- APPLIED FOR EXPOSED PAD AND TERMINALS.  
EXCLUDE EMBEDDED PART OF EXPOSED PAD FROM MEASURING.
- MEETS JEDEC MO220.
- THIS PACKAGE OUTLINE APPLIES TO ANVIL SINGULATION (STEPPED SIDES) AND TO SAW SINGULATION (STRAIGHT SIDES) QFN STYLES.

Symbol	COMMON DIMENSIONS			Symbol
	MIN.	NOM.	MAX.	
A	0.80	0.90	1.00	
A1	0.00	0.01	0.05	
A2	0.00	0.65	1.00	
A3	0.20 REF.			
D	5.00 BSC			
D1	4.75 BSC			
E	5.00 BSC			
E1	4.75 BSC			
θ	0°	-	12°	
P	0	-	0.60	
D2	1.25	-	3.25	
E2	1.25	-	3.25	

Symbol	PITCH VARIATION B			Symbol	PITCH VARIATION B			Symbol	PITCH VARIATION C			Symbol	PITCH VARIATION D		
	MIN.	NOM.	MAX.												
θ	0.60 BSC			θ	0.60 BSC			θ	0.50 BSC			θ	0.50 BSC		
N	4	3	N	20	3	N	28	3	N	32	3	3	3	3	
Nd	4	3	Nd	5	3	Nd	7	3	Nd	8	3	3	3	3	
Ne	4	3	Ne	5	3	Ne	7	3	Ne	8	3	3	3	3	
L	0.35	0.55	0.75	L	0.35	0.55	0.75	L	0.35	0.55	0.75	L	0.30	0.40	0.50
b	0.28	0.33	0.40	b	0.23	0.28	0.35	b	0.18	0.23	0.30	b	0.18	0.23	0.30

**MAXIM**  
PREPROPRIETARY INFORMATION  
TITLE: PACKAGE OUTLINE, 16,20,28,32L QFN, 5x5x0.90 MM  
APPROVAL: DOCUMENT CONTROL NO. 21-0091 REV G 2/2

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